03-02-2000



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Patent and Trademark Office

| To | the Honorable | Commissioner | of Patents and Ti |
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il documents or copy thereof.

| 1. | | aveying party(ies): Jian-Hsing Lee, Yi-Hsun Hung Chen and Jiaw-Ren Shih | | |
|----|--|--|--|--|
| | Additional name(s) of conveying party(ies) attached? | | | |
| | []Yes | [X] No | | |

Name and address of receiving party(ies)

Name: Taiwan Semiconductor Manufacturing Co.,

Address: No. 9, Creation Rd. 1, Science-Based

Industrial Park, Hsinchu, Taiwan, R.O.C.

3. Nature of conveyance:

[X] Assignment

[] Merger

[] Security Agreement

[] Change of Name

Other ____

City: _ State: _ Zip: _ Additional name(s) and address(es) attached? []Yes [X] No



Execution Date: January 10, 2000

Application number(s) or patent number(s)

Patent Application No.(s)

B. Patent No.(s)

09/494682

Additional numbers attached?

[]Yes

[X] No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Ronald B. Hildreth

BAKER BOTTS L.L.P.

Address: 30 Rockefeller Plaza - 44 Fl.

City: New York State: NY Zip: 10112

Total number of applications and patents involved:

Total fee (37 CFR 3.41):

\$ 40.00

[X] Enclosed

[] Authorized to be charged to deposit account

Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature

> To the best of my knowledge and belief, the foregoing inforumentation is true and correct and any attached copy is a true copy of the original document. mala

Ronald B. Hildreth, PTO# 19,498

Name of Person Signing

January 31, 2000

Total number of pages including cover sheet, attachments and document:

03/03/2000 DNGUYEN 00000033 0949#682

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PATENT REEL: 010575 FRAME: 0945

ASSIGNMENT

A 32763

| This assignment agreement is applicable to an invention entitled (invention Title) |
|--|
| NOVEL N-TYPE STRUCTURE FOR N-TYPE PULL-UP AND DOWN I/O |
| PROTECTION CIRCUIT |
| |
| The PATENT RIGHTS referred to in this agreement are: |
| (check one) a patent application for this invention, executed by the ASSIGNOR(S) |
| concurrently with this assignment. |
| U.S. patent application Serial No,filed |
| ☐a U.S. patent application based on PCT International Application |
| Nofiled on (date)(U.S. patent application |
| Serial No, if known). |
| U.S. patent No, issued |
| The PATENT RIGHTS also include all divisions reissues, continuations and extensions of the |
| patents and patent applications identified above. |
| The PATENT RIGHTS assigned under this agreement are: |
| (check one) U.S. patent rights only. |
| ☐Worldwide patent rights. In this case, the assignee shall have the right to |
| claim the benefit of the filing date of any U.S. or foreign patent application |
| for this invention. |
| The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures |
| appear on page 2 of this Assignment and any Supplemental Sheet(s). |
| The ASSIGNEE referred to in this agreement is: |
| (Name of Assignee) TAIWAN, SEMICONDUCTOR MANUFACTURING CO., LTD. |
| (Address) NO.9, CREATION RD.1, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU, |
| TAIWAN, R.O.C. |
| The ASSIGNEE is: |
| (check one) ☐ An individual. |
| ☐A Partnership. |
| A Corporation of <u>TAIWAN, R.O.C.</u> (specify state or country) |
| (other) |
| |
| The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and |
| valuable consideration, receipt of which is acknowledged, hereby assign(s) the following |
| rights to the ASSIGNEE, its successors and assigns: |
| the full and exclusive right to the invention; |
| the entire right, title and interest in and to the PATENT RIGHTS; |
| the right to sue and recover for any past infringement; and |
| the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions |
| based on any earlier patent applications for this invention. |

PATENT REEL: 010575 FRAME: 0946

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: TAIWAN, SEMICONDUCTOR MANUFACTURING CO., LTD. INVENTION TITLE: NOVEL N-TYPE STRUCTURE FOR N-TYPE PULL-UP AND DOWN I/O PROTECTION CIRCUIT

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been excuted.

| Jian-Hsing LEE | Time-Hsing Lee | 1, 10 / 2000 |
|--|-----------------------------|--------------|
| Name of sole or first inventor | Signature | Date |
| Yi-Hsun WU Name of second inventor, if any | Signature | Date |
| Shui-Hung CHEN Name of third inventor, if any | Shuit - Hung Chen Signature | Date |
| Jiaw-Ren SHIH Name of fourth inventor, if any | Signature | Date Deor |
| Name of fifth inventor, if any | Signature | Date |
| Name of sixth inventor, if any | Signature | Date |
| Name of seventh inventor, if any | Signature | Date |
| Name of eighth inventor, if any | Signature | Date |

RECORDED: 01/31/2000

PATENT REEL: 010575 FRAME: 0947